

T9090U-UNL1 Series High Power UV LED

Introduction

The T9090U-UNL1 product is a compact, high quality and reliable 12-chip UV LED. Featuring high radiometric power density and design flexibility - the T9090U-UNL1 spectrum can be tailored to your printer, inkjet, glue adhesive curing, and other general purpose UV applications.

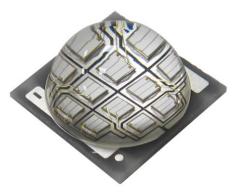


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RoHS Compliant

Characteristics

Absolute Maximum Ratings (T_j = 25°C)

Parameter	Rating		
Parameter	UV Series		
DC Forward Current (mA) *	700 mA		
LED Junction Temperature	150°C		
LED Operating Temperature	-40°C ~ 85°C		
Storage Temperature	-40°C ~ 125°C		
Soldering Temperature	Max. 260°C / Max. 10sec. (JEDEC 020)		
ESD Sensitivity	2,000 V HBM (JESD-22A-114-B)		
Reverse Voltage	Not designed to be driven in reverse bias (VR \leq 5V)		
Preconditioning	Acc. to JEDEC Level 2		

* Ambient temperature is well-controlled under $85^{\circ}C$

General Characteristics at 350mA

Part number	Color	Peak Wave	Wavelength λp 2		Temperature Coefficient of Vf (mV/°C)	Thermal Resistance Junction to Pad
		Min	Max		ΔVF /ΔTJ	(°C/W) RΘ _{J-L}
T9090U-UNL1	U40	380	390	140	-12.4	1.9
	U50	390	400	140	-12.4	1.9
	U60	400	410	140	-12.4	1.9
	U70	410	420	140	-12.4	1.9

Notes:

- 1. The peak wavelength is measured with an accuracy of ±1nm
- 2. All values stated are subject to the limits and set up of TSLC's testers. All other measurement data are defined as long-term production mean values and are only given for reference.
- 3. A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or effectiveness of that device or system. Life support devices or systems are intended (i) to be implanted in the human body, or (ii) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered. Components used as a critical component must be approved in writing by TSLC Corporation.
- 4. These devices emit high intensity UV/NUV light. Necessary precautions must be taken during operation. Do not look directly into the light or look through the optical system when in operation. Protective eyewear should be worn at all times during operation.
- 5. Do not drive at rated current for more than 1 second without proper thermal management.
- 6. Always follow thermal design recommendations in the relevant Application Note.



	Color	Perfe	ormance at Test Current	Performance at 700mA		
Part number			Minimum Radiometric	VF		*Calculated Minimum
		Group	Power (W)	Min	Max	Radiation Power (W)
	U40	NK4	5.5	33.6	44.4	9.9
T9090U-UNL1		NK5	6.0	33.6	44.4	10.8
		NK6	6.5	33.6	44.4	11.7
	U50	NK4	5.5	33.6	44.4	9.9
		NK5	6.0	33.6	44.4	10.8
		NK6	6.5	33.6	44.4	11.7
	U60	NK4	5.5	33.6	44.4	9.9
		NK5	6.0	33.6	44.4	10.8
		NK6	6.5	33.6	44.4	11.7
	U70	NK4	5.5	33.6	44.4	9.9
		NK5	6.0	33.6	44.4	10.8
		NK6	6.5	33.6	44.4	11.7

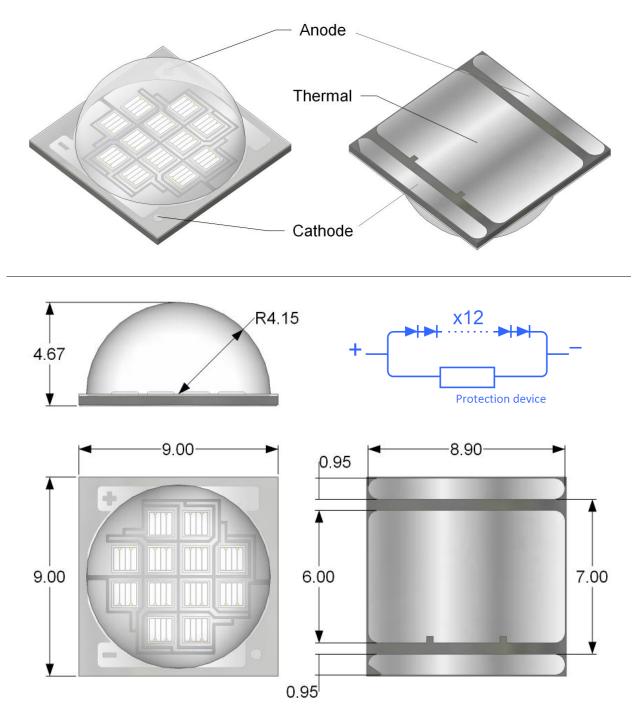
Radiometric Power and Forward Voltage (T_j = 25°C)

Note: 1. Radiometric power is measured with an accuracy of $\pm 10\%$

- 2. The forward voltage is measured with an accuracy of $\pm 0.2 \text{V}$
- * Calculated values are for reference only.



Mechanical Dimensions



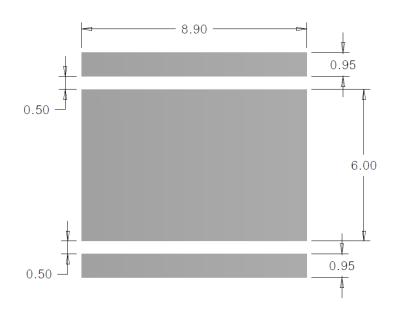
Notes :

- 1. Drawing is not to scale
- 2. All dimensions are in millimeter
- 3. Dimensions are ± 0.13 mm unless otherwise indicated

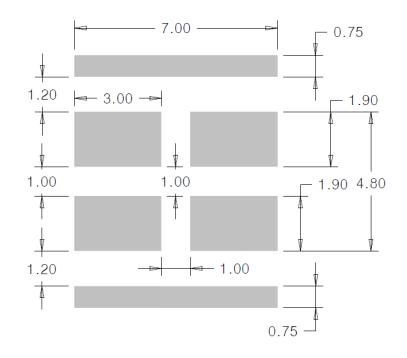


Recommended Solder Pad Design

Recommended Soldering Pad Design



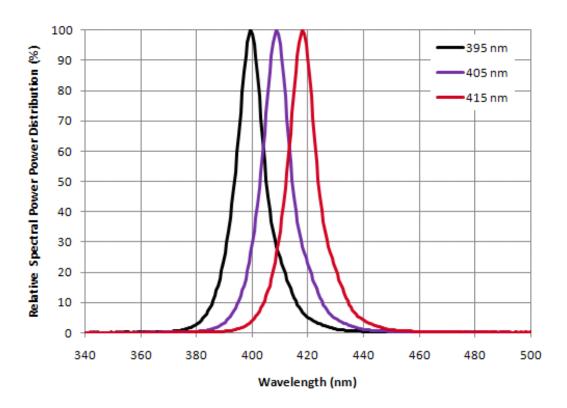
Recommended Stencil Pattern Design (Marked Area is Opening)



Notes :

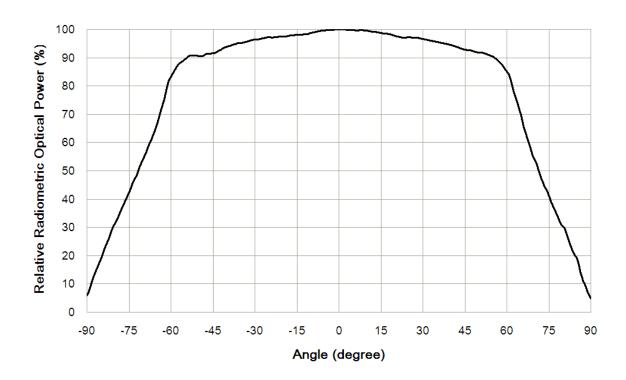
- 1. Drawing is not to scale
- 2. All dimensions are in millimeter



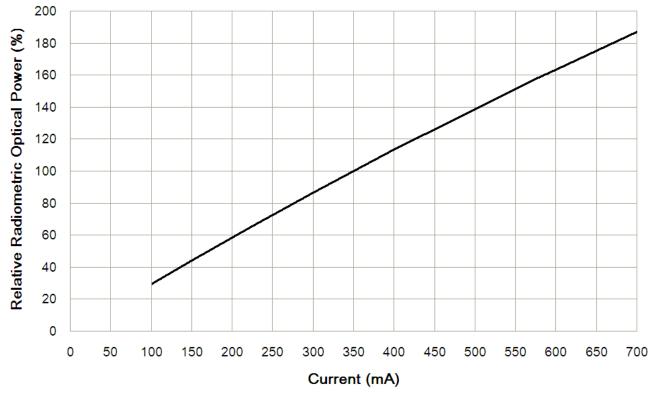


Relative Spectral Power Distribution, Tj=25°C

Typical Spatial Radiation Pattern

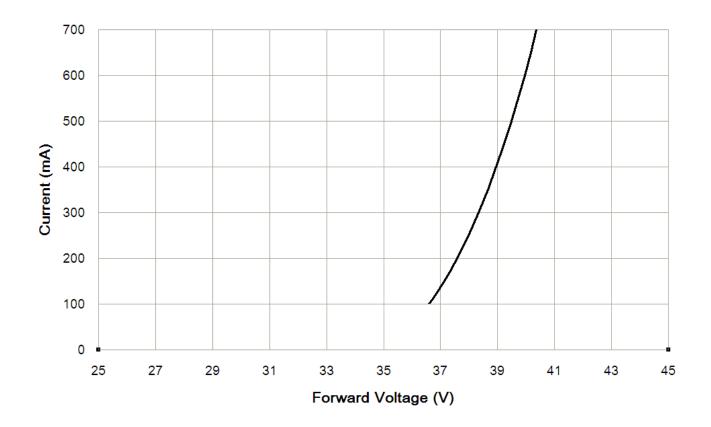






Typical Forward L-I Characteristics, T_j=25°C

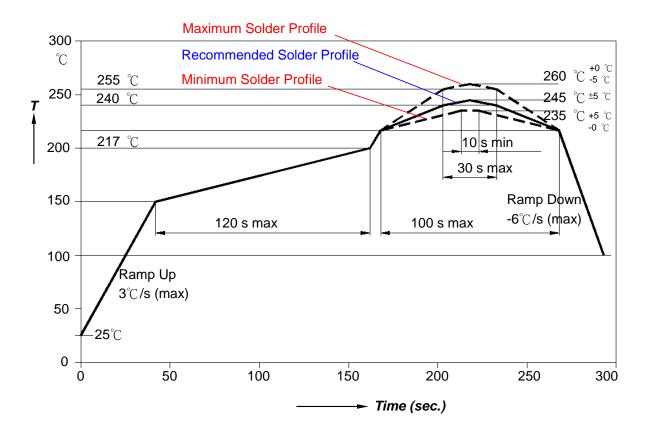






Recommended Soldering Profile

The LEDs can be soldered using the parameters listed below. As a general guideline, the users are suggested to follow the recommended soldering profile provided by the manufacturer of the solder paste. Although the recommended soldering conditions are specified in the list, reflow soldering at the lowest possible temperature is advised for the LEDs.

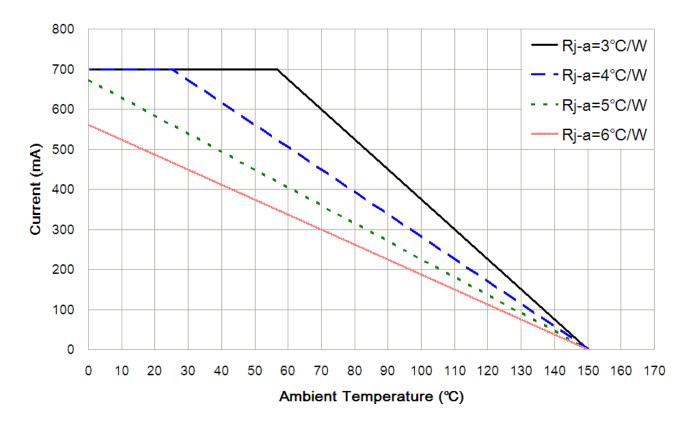


Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly		
Average Ramp-up Rate (Ts _{max} to Tp)	3°C /second max.	3°C /second max.		
Preheat				
- Temperature Min(Ts _{min})	100°C	150°C		
- Temperature Max(Ts _{max})	150°C	200°C		
- Time(ts _{min} to ts _{max})	60-120 seconds	60-180 seconds		
Time maintained above:				
- Temperature(T _L)	183°C	217°C		
- Time(t _L)	60-150 seconds	60-150 seconds		
Peak/classification	215°C	260°C		
Temperature(Tp)				
Time within 5°C of actual Peak	10.20 accords	20.40 seconds		
Temperature(tp)	10-30 seconds	20-40 seconds		
Ramp-Down Rate	6°C /second max.	6°C /second max.		
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.		



Thermal Design

Thermal design of the end product is important. The thermal resistance between the junction and the solder point $(R\Theta_{J-P})$ and the end product should be designed to minimize the thermal resistance from the solder point to ambient in order to optimize the emitter life and optical characteristics. The maximum operation current is determined by the plot of Allowable Forward Current vs. Ambient Temperature.



The junction temperature can be correlated to the thermal resistance between the junction and ambient (Rja) by the following equation.

Tj=Ta + Rja*W

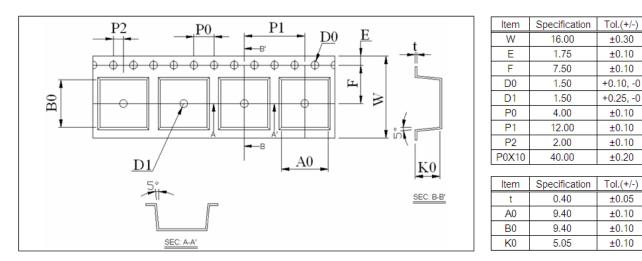
Tj: LED junction temperature

Ta: Ambient temperature

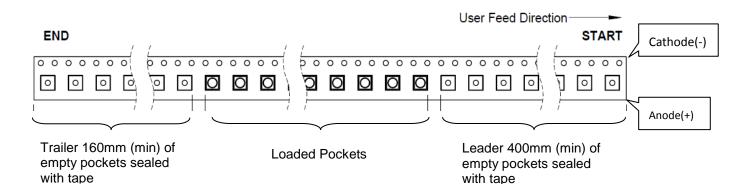
Rja: Thermal resistance between the junction and ambient

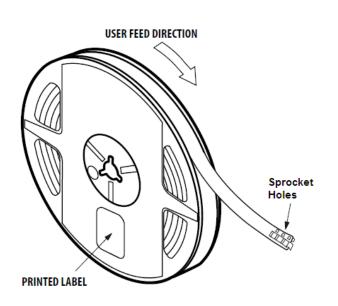
W: Input power $(I_F * V_F)$





Package Information





Note: All dimensions are in millimeter.



About Us

TSLC Corporation is devoted to developing high-density, and multi-size emitters with powerful output to satisfy the needs of every customer.

TSLC Corporation is the leader in LED solutions. Unlimited design flexibility for interior and exterior spaces with high-end lighting effect; energy-efficient for UV curing to improve the quality of medical care; horticulture solutions create a better environment for everyone; high-intensity rotatable lightings for the entertainment industry, TSLC is always there for your lighting needs.

For further company or product information, please visit us at www.tslc.com.tw or please contact sales@ tslc.com.tw.





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